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Details

Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	40 MIPS
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	21
Program Memory Size	12KB (4K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 10x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24hj12gp202t-i-ml

PIC24HJ12GP201/202

PIC24HJ12GP201/202 Product Families

The device names, pin counts, memory sizes and peripheral availability of each family are listed below, followed by their pinout diagrams.

TABLE 1: PIC24HJ12GP201/202 CONTROLLER FAMILIES

Device	Pins	Program Flash Memory (Kbyte)	RAM (Kbyte)	Remappable Peripherals							10-Bit/12-Bit ADC	I ² C™	I/O Pins (Max)	Packages
				Remappable Pins	16-bit Timer	Input Capture	Output Compare Std. PWM	UART	External Interrupts ⁽²⁾	SPI				
PIC24HJ12GP201	18	12	1	8	3 ⁽¹⁾	4	2	1	3	1	1 ADC, 6 ch	1	13	PDIP SOIC
PIC24HJ12GP202	28	12	1	16	3 ⁽¹⁾	4	2	1	3	1	1 ADC, 10 ch	1	21	SPDIP SOIC SSOP QFN

Note 1: Only two out of three timers are remappable.

2: Only two out of three interrupts are remappable.

4.2.5 SOFTWARE STACK

In addition to its use as a working register, the W15 register in the PIC24HJ12GP201/202 devices is also used as a software Stack Pointer. The Stack Pointer always points to the first available free word and grows from lower to higher addresses. It pre-decrements for stack pops and post-increments for stack pushes, as shown in Figure 4-4. For a PC push during any CALL instruction, the MSB of the PC is zero-extended before the push, ensuring that the MSB is always clear.

Note: A PC push during exception processing concatenates the SRL register to the MSB of the PC prior to the push.

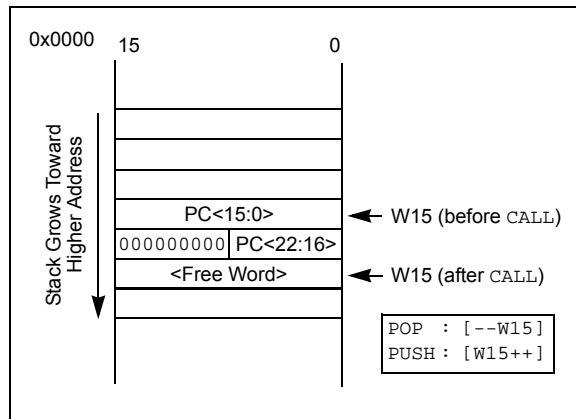
The Stack Pointer Limit register (SPLIM) associated with the Stack Pointer sets an upper address boundary for the stack. SPLIM is uninitialized at Reset. As is the case for the Stack Pointer, SPLIM<0> is forced to '0' because all stack operations must be word-aligned.

When an EA is generated using W15 as a source or destination pointer, the resulting address is compared with the value in SPLIM. If the contents of the Stack Pointer (W15) and the SPLIM register are equal and a push operation is performed, a stack error trap will not occur. However, the stack error trap will occur on a subsequent push operation. For example, to cause a stack error trap when the stack grows beyond address 0x0C00 in RAM, initialize the SPLIM with the value 0x0BFE.

Similarly, a Stack Pointer underflow (stack error) trap is generated when the Stack Pointer address is found to be less than 0x0800. This prevents the stack from interfering with the SFR space.

A write to the SPLIM register should not be immediately followed by an indirect read operation using W15.

FIGURE 4-4: CALL STACK FRAME



4.2.6 DATA RAM PROTECTION FEATURE

The PIC24H product family supports Data RAM protection features that enable segments of RAM to be protected when used in conjunction with Boot and Secure Code Segment Security. BSRAM (Secure RAM segment for BS) is accessible only from the Boot Segment Flash code, when it is enabled. SSRAM (Secure RAM segment for RAM) is accessible only from the Secure Segment Flash code, when it is enabled. See Table 4-1 for an overview of the BSRAM and SSRAM SFRs.

4.3 Instruction Addressing Modes

The addressing modes shown in Table 4-22 form the basis of the addressing modes that are optimized to support the specific features of individual instructions. The addressing modes provided in the MAC class of instructions differ from those provided by other instruction types.

4.3.1 FILE REGISTER INSTRUCTIONS

Most file register instructions use a 13-bit address field (f) to directly address data present in the first 8192 bytes of data memory (Near Data Space). Most file register instructions employ a working register, W0, which is denoted as WREG in these instructions. The destination is typically either the same file register or WREG (with the exception of the MUL instruction), which writes the result to a register or register pair. The MOV instruction allows additional flexibility and can access the entire data space.

4.3.2 MCU INSTRUCTIONS

The three-operand MCU instructions are of the form:

Operand 3 = Operand 1 <function> Operand 2

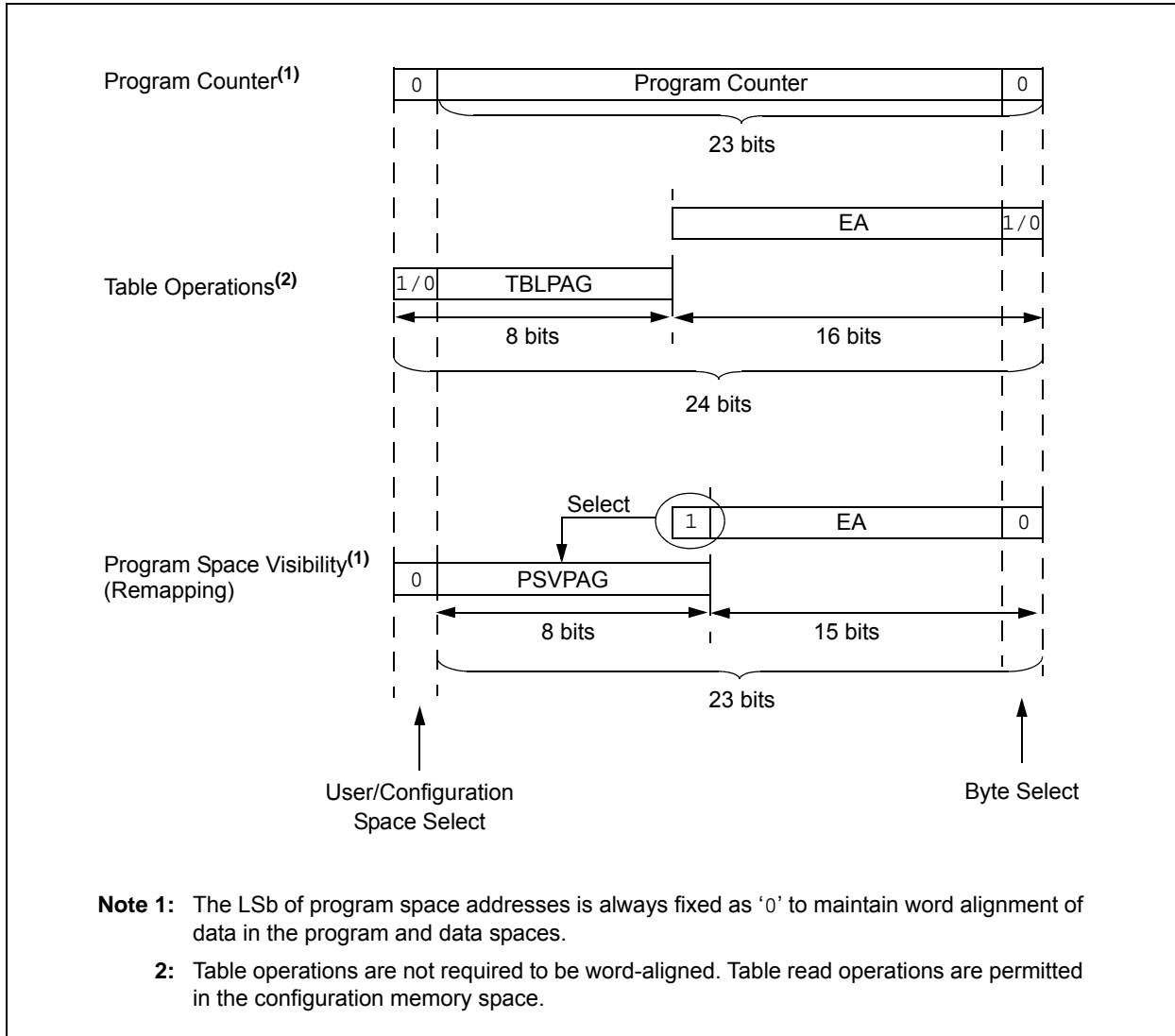
where Operand 1 is always a working register (that is, the addressing mode can only be register direct), which is referred to as Wb. Operand 2 can be a W register, fetched from data memory, or a 5-bit literal. The result location can be either a W register or a data memory location. The following addressing modes are supported by MCU instructions:

- Register Direct
- Register Indirect
- Register Indirect Post-Modified
- Register Indirect Pre-Modified
- 5-bit or 10-bit Literal

Note: Not all instructions support all the addressing modes given above. Individual instructions can support different subsets of these addressing modes.

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FIGURE 4-5: DATA ACCESS FROM PROGRAM SPACE ADDRESS GENERATION



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REGISTER 6-1: RCON: RESET CONTROL REGISTER⁽¹⁾

R/W-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
TRAPR	IOPUWR	—	—	—	—	CM	VREGS
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1
EXTR	SWR	SWDTEN ⁽²⁾	WDTO	SLEEP	IDLE	BOR	POR
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

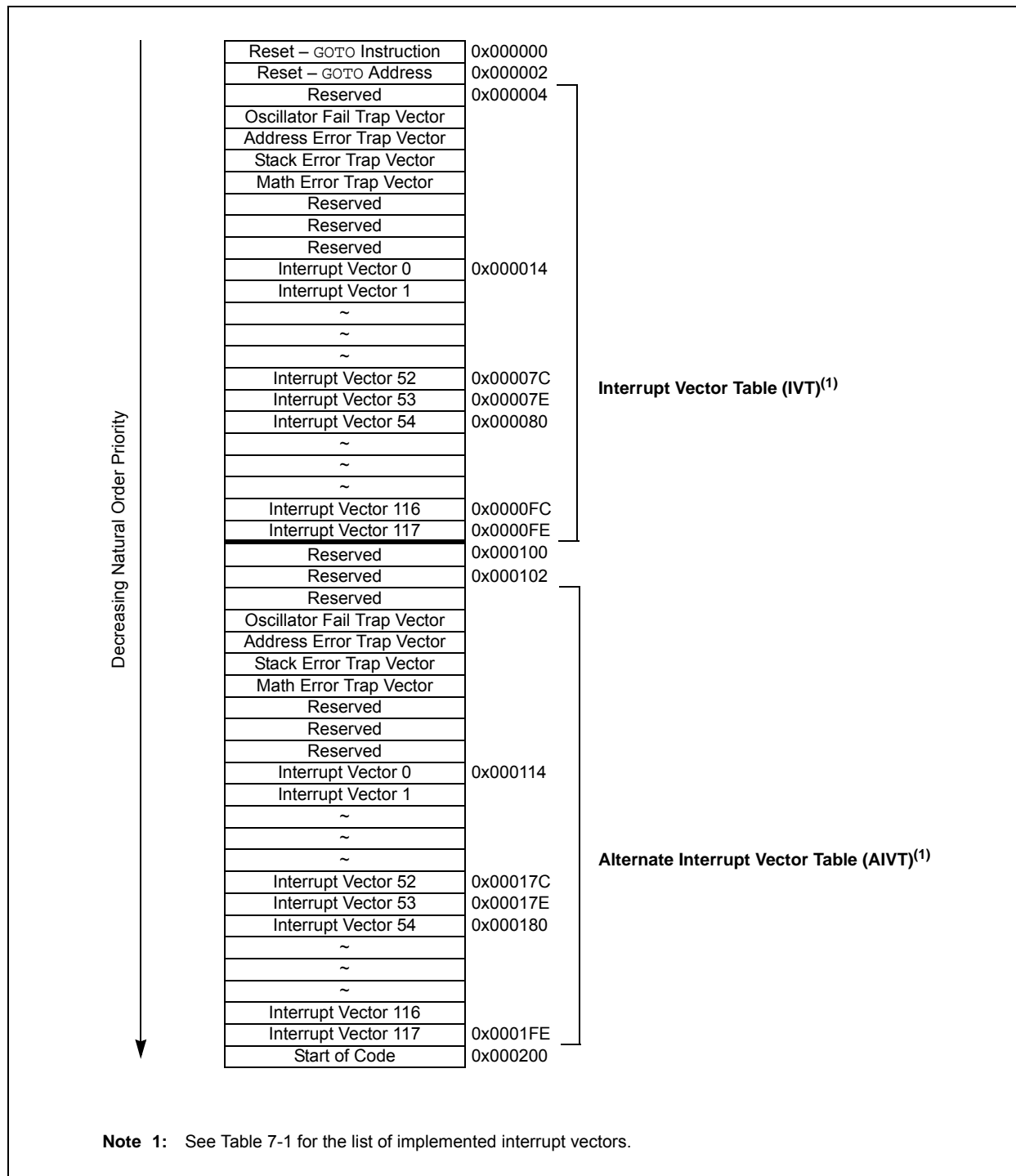
- bit 15 **TRAPR:** Trap Reset Flag bit
 1 = A Trap Conflict Reset has occurred
 0 = A Trap Conflict Reset has not occurred
- bit 14 **IOPUWR:** Illegal Opcode or Uninitialized W Access Reset Flag bit
 1 = An illegal opcode detection, an illegal address mode or uninitialized W register used as an Address Pointer caused a Reset
 0 = An illegal opcode or uninitialized W Reset has not occurred
- bit 13-10 **Unimplemented:** Read as '0'
- bit 9 **CM:** Configuration Mismatch Flag bit
 1 = A configuration mismatch Reset has occurred
 0 = A configuration mismatch Reset has not occurred
- bit 8 **VREGS:** Voltage Regulator Standby During Sleep bit
 1 = Voltage regulator is active during Sleep
 0 = Voltage regulator goes into Standby mode during Sleep
- bit 7 **EXTR:** External Reset ($\overline{\text{MCLR}}$) Pin bit
 1 = A Master Clear (pin) Reset has occurred
 0 = A Master Clear (pin) Reset has not occurred
- bit 6 **SWR:** Software Reset (Instruction) Flag bit
 1 = A RESET instruction has been executed
 0 = A RESET instruction has not been executed
- bit 5 **SWDTEN:** Software Enable/Disable of WDT bit⁽²⁾
 1 = WDT is enabled
 0 = WDT is disabled
- bit 4 **WDTO:** Watchdog Timer Time-out Flag bit
 1 = WDT time-out has occurred
 0 = WDT time-out has not occurred
- bit 3 **SLEEP:** Wake-up from Sleep Flag bit
 1 = Device has been in Sleep mode
 0 = Device has not been in Sleep mode
- bit 2 **IDLE:** Wake-up from Idle Flag bit
 1 = Device was in Idle mode
 0 = Device was not in Idle mode

Note 1: All of the Reset status bits can be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

2: If the FWDTEN Configuration bit is '1' (unprogrammed), the WDT is always enabled, regardless of the SWDTEN bit setting.

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FIGURE 7-1: PIC24HJ12GP201/202 INTERRUPT VECTOR TABLE



REGISTER 7-16: IPC5: INTERRUPT PRIORITY CONTROL REGISTER 5

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	IC8IP<2:0>			—	IC7IP<2:0>		
bit 15				bit 8			

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
—	—	—	—	—	INT1IP<2:0>		
bit 7					bit 0		

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **IC8IP<2:0>:** Input Capture Channel 8 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•
•
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **IC7IP<2:0>:** Input Capture Channel 7 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•
•
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7-3 **Unimplemented:** Read as '0'

bit 2-0 **INT1IP<2:0>:** External Interrupt 1 Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•
•
•

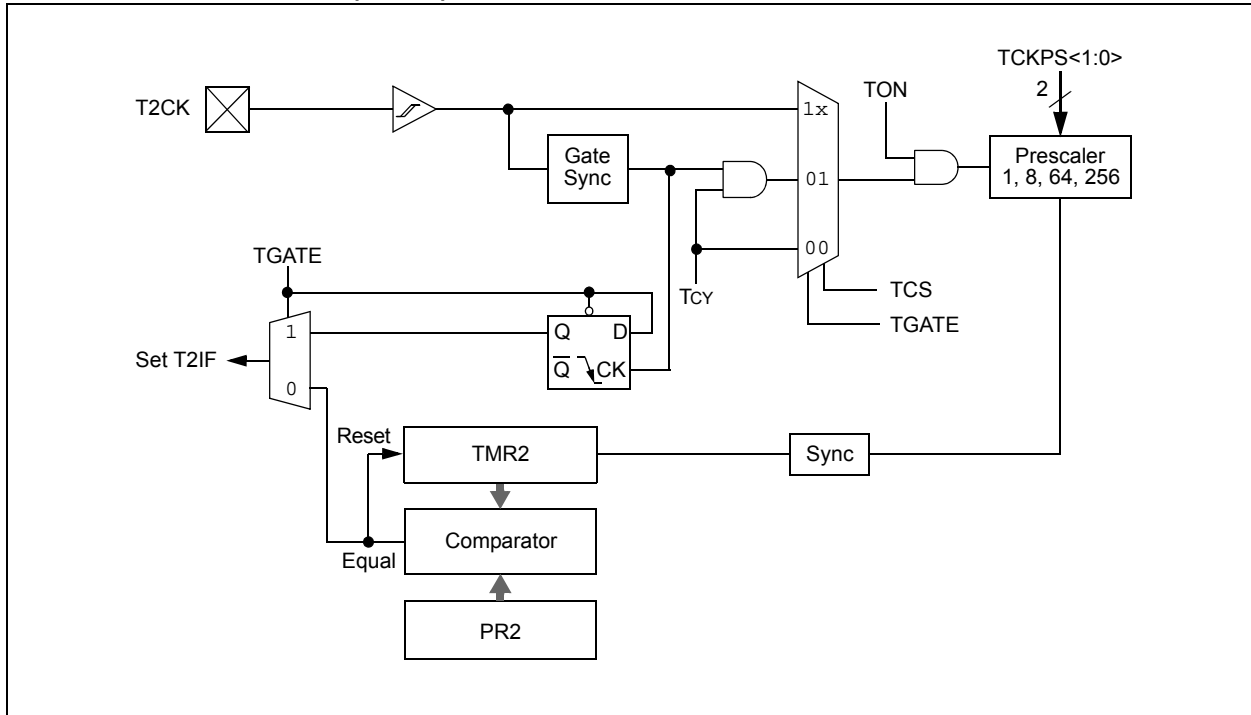
001 = Interrupt is priority 1

000 = Interrupt source is disabled

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NOTES:

FIGURE 12-2: TIMER2 (16-BIT) BLOCK DIAGRAM



REGISTER 15-2: SPIxCON1: SPIx CONTROL REGISTER 1

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	DISSCK	DISSDO	MODE16	SMP	CKE ⁽¹⁾
bit 15			bit 8				
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SSEN ⁽²⁾	CKP	MSTEN	SPRE<2:0> ⁽³⁾			PPRE<1:0> ⁽³⁾	
bit 7			bit 0				

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

- bit 15-13 **Unimplemented:** Read as '0'
- bit 12 **DISSCK:** Disable SCKx pin bit (SPI Master modes only)
 1 = Internal SPI clock is disabled, pin functions as I/O
 0 = Internal SPI clock is enabled
- bit 11 **DISSDO:** Disable SDOx pin bit
 1 = SDOx pin is not used by module; pin functions as I/O
 0 = SDOx pin is controlled by the module
- bit 10 **MODE16:** Word/Byte Communication Select bit
 1 = Communication is word-wide (16 bits)
 0 = Communication is byte-wide (8 bits)
- bit 9 **SMP:** SPIx Data Input Sample Phase bit
Master mode:
 1 = Input data sampled at end of data output time
 0 = Input data sampled at middle of data output time
Slave mode:
 SMP must be cleared when SPIx is used in Slave mode.
- bit 8 **CKE:** SPIx Clock Edge Select bit⁽¹⁾
 1 = Serial output data changes on transition from active clock state to Idle clock state (see bit 6)
 0 = Serial output data changes on transition from Idle clock state to active clock state (see bit 6)
- bit 7 **SSEN:** Slave Select Enable bit (Slave mode)⁽²⁾
 1 = \overline{SSx} pin used for Slave mode
 0 = \overline{SSx} pin not used by module. Pin controlled by port function.
- bit 6 **CKP:** Clock Polarity Select bit
 1 = Idle state for clock is a high level; active state is a low level
 0 = Idle state for clock is a low level; active state is a high level
- bit 5 **MSTEN:** Master Mode Enable bit
 1 = Master mode
 0 = Slave mode

- Note 1:** The CKE bit is not used in the Framed SPI modes. Program this bit to '0' for the Framed SPI modes (FRMEN = 1).
- 2:** This bit must be cleared when FRMEN = 1.
- 3:** Do not set both Primary and Secondary prescalers to a value of 1:1.

16.0 INTER-INTEGRATED CIRCUIT™ (I²C™)

Note 1: This data sheet summarizes the features of the PIC24HJ12GP201/202 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to “**Section 19. Inter-Integrated Circuit™ (I²C™)**” (DS70195) of the “*dsPIC33F/PIC24H Family Reference Manual*”, which is available from the Microchip website (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The Inter-Integrated Circuit™ (I²C™) module provides complete hardware support for both Slave and Multi-Master modes of the I²C serial communication standard, with a 16-bit interface.

The I²C module has a 2-pin interface:

- The SCLx pin is clock
- The SDAx pin is data

The I²C module offers the following key features:

- I²C interface supporting both Master and Slave modes of operation
- I²C Slave mode supports 7-bit and 10-bit addresses
- I²C Master mode supports 7-bit and 10-bit addresses
- I²C port allows bidirectional transfers between master and slaves
- Serial clock synchronization for I²C port can be used as a handshake mechanism to suspend and resume serial transfer (SCLREL control)
- I²C supports multi-master operation, detects bus collision and arbitrates accordingly

16.1 Operating Modes

The hardware fully implements all the master and slave functions of the I²C Standard and Fast mode specifications, as well as 7-bit and 10-bit addressing.

The I²C module can operate either as a slave or a master on an I²C bus.

The following types of I²C operation are supported:

- I²C slave operation with 7-bit address
- I²C slave operation with 10-bit address
- I²C master operation with 7-bit or 10-bit address

For details about the communication sequence in each of these modes, refer to the Microchip web site (www.microchip.com) for the latest “*dsPIC33F/PIC24H Family Reference Manual*” sections.

16.2 I²C Registers

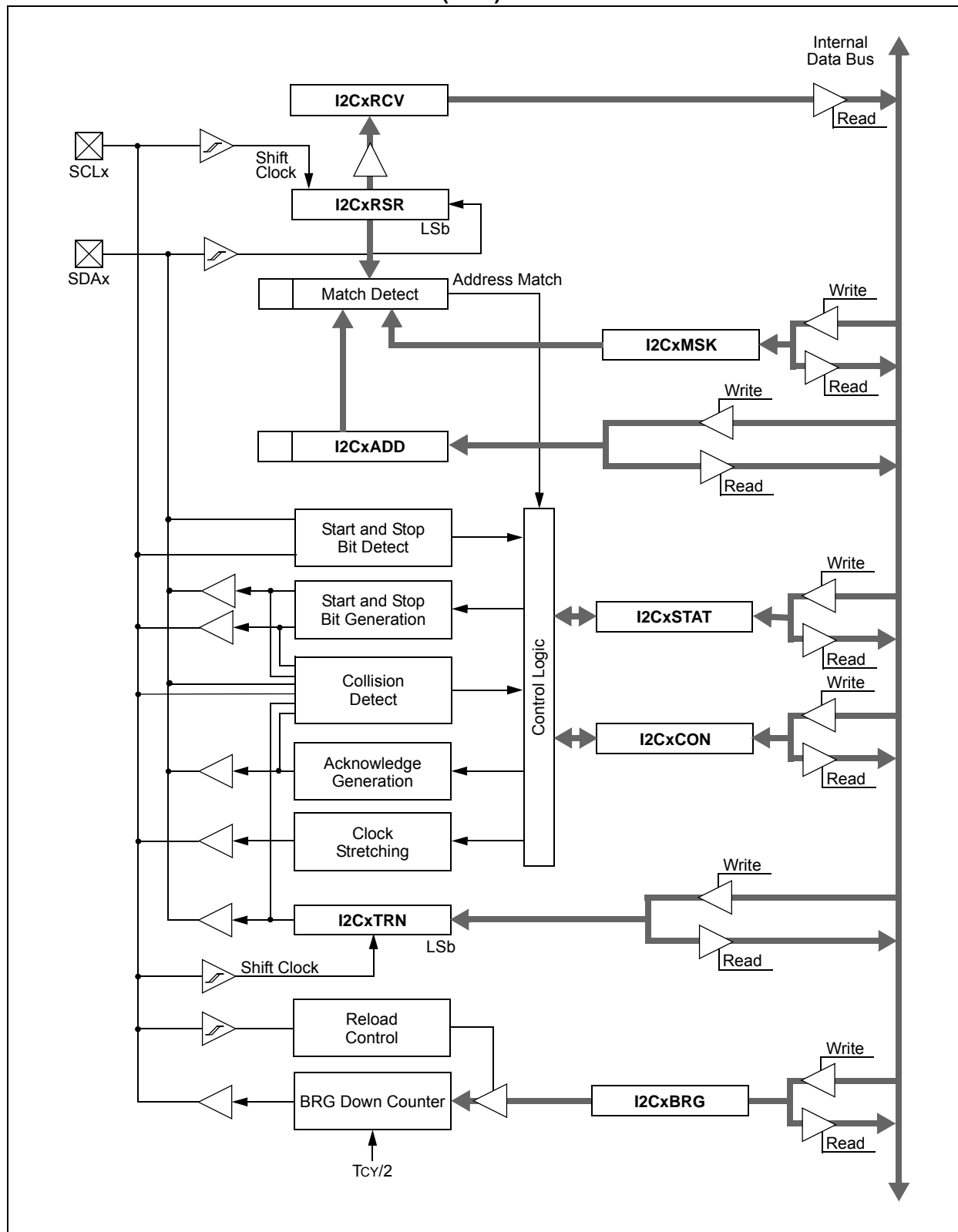
I2CxCON and I2CxSTAT are control and status registers, respectively. The I2CxCON register is readable and writable. The lower six bits of I2CxSTAT are read-only. The remaining bits of the I2CxSTAT are read/write.

- I2CxRSR is the shift register used for shifting data
- I2CxRCV is the receive buffer and the register to which data bytes are written, or from which data bytes are read
- I2CxTRN is the transmit register to which bytes are written during a transmit operation
- I2CxADD register holds the slave address
- ADD10 status bit indicates 10-bit Address mode
- I2CxBRG acts as the Baud Rate Generator (BRG) reload value

In receive operations, I2CxRSR and I2CxRCV together form a double-buffered receiver. When I2CxRSR receives a complete byte, it is transferred to I2CxRCV, and an interrupt pulse is generated.

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FIGURE 16-1: I²C™ BLOCK DIAGRAM (x = 1)



REGISTER 17-1: UxMODE: UARTx MODE REGISTER (CONTINUED)

bit 4	URXINV: Receive Polarity Inversion bit 1 = UxRX Idle state is '0' 0 = UxRX Idle state is '1'
bit 3	BRGH: High Baud Rate Enable bit 1 = BRG generates 4 clocks per bit period (4x baud clock, High-Speed mode) 0 = BRG generates 16 clocks per bit period (16x baud clock, Standard mode)
bit 2-1	PDSEL<1:0>: Parity and Data Selection bits 11 = 9-bit data, no parity 10 = 8-bit data, odd parity 01 = 8-bit data, even parity 00 = 8-bit data, no parity
bit 0	STSEL: Stop Bit Selection bit 1 = Two Stop bits 0 = One Stop bit

Note 1: Refer to **Section 17. "UART"** (DS70188) in the *"dsPIC33F/PIC24H Family Reference Manual"* for information on enabling the UART module for receive or transmit operation.

2: This feature is only available for the 16x BRG mode (BRGH = 0).

REGISTER 17-2: UxSTA: UARTx STATUS AND CONTROL REGISTER (CONTINUED)

bit 5	ADDEN: Address Character Detect bit (bit 8 of received data = 1) 1 = Address Detect mode enabled. If 9-bit mode is not selected, this does not take effect. 0 = Address Detect mode disabled
bit 4	RIDLE: Receiver Idle bit (read-only) 1 = Receiver is Idle 0 = Receiver is active
bit 3	PERR: Parity Error Status bit (read-only) 1 = Parity error has been detected for the current character (character at the top of the receive FIFO) 0 = Parity error has not been detected
bit 2	FERR: Framing Error Status bit (read-only) 1 = Framing error has been detected for the current character (character at the top of the receive FIFO) 0 = Framing error has not been detected
bit 1	OERR: Receive Buffer Overrun Error Status bit (read-only/clear-only) 1 = Receive buffer has overflowed 0 = Receive buffer has not overflowed. Clearing a previously set OERR bit (1 → 0 transition) will reset the receiver buffer and the UxRSR to the empty state.
bit 0	URXDA: Receive Buffer Data Available bit (read-only) 1 = Receive buffer has data, at least one more character can be read 0 = Receive buffer is empty

Note 1: Refer to **Section 17. “UART”** (DS70188) in the “*dsPIC33F/PIC24H Family Reference Manual*” for information on enabling the UART module for transmit operation.

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TABLE 19-2: PIC24HJ12GP201/202 CONFIGURATION BITS DESCRIPTION

Bit Field	Register	RTSP Effect	Description
BWRP	FBS	Immediate	Boot Segment Program Flash Write Protection 1 = Boot segment may be written 0 = Boot segment is write-protected
BSS<2:0>	FBS	Immediate	Boot Segment Program Flash Code Protection Size x11 = No Boot program Flash segment Boot space is 256 Instruction Words (except interrupt vectors) 110 = Standard security; boot program Flash segment ends at 0x0003FE 010 = High security; boot program Flash segment ends at 0x0003FE Boot space is 768 Instruction Words (except interrupt vectors) 101 = Standard security; boot program Flash segment, ends at 0x0007FE 001 = High security; boot program Flash segment ends at 0x0007FE Boot space is 1792 Instruction Words (except interrupt vectors) 100 = Standard security; boot program Flash segment ends at 0x000FFE 000 = High security; boot program Flash segment ends at 0x000FFE
GSS<1:0>	FGS	Immediate	General Segment Code-Protect bit 11 = User program memory is not code-protected 10 = Standard security 0x = High security
GWRP	FGS	Immediate	General Segment Write-Protect bit 1 = User program memory is not write-protected 0 = User program memory is write-protected
IESO	FOSCSEL	Immediate	Two-speed Oscillator Start-up Enable bit 1 = Start-up device with FRC, then automatically switch to the user-selected oscillator source when ready 0 = Start-up device with user-selected oscillator source
FNOSC<2:0>	FOSCSEL	If clock switch is enabled, RTSP effect is on any device Reset; otherwise, Immediate	Initial Oscillator Source Selection bits 111 = Internal Fast RC (FRC) oscillator with postscaler 110 = Internal Fast RC (FRC) oscillator with divide-by-16 101 = LPRC oscillator 100 = Secondary (LP) oscillator 011 = Primary (XT, HS, EC) oscillator with PLL 010 = Primary (XT, HS, EC) oscillator 001 = Internal Fast RC (FRC) oscillator with PLL 000 = FRC oscillator
FCKSM<1:0>	FOSC	Immediate	Clock Switching Mode bits 1x = Clock switching is disabled, fail-safe clock monitor is disabled 01 = Clock switching is enabled, fail-safe clock monitor is disabled 00 = Clock switching is enabled, fail-safe clock monitor is enabled
IOL1WAY	FOSC	Immediate	Peripheral Pin Select Configuration 1 = Allow only one reconfiguration 0 = Allow multiple reconfigurations
OSCIOFNC	FOSC	Immediate	OSC2 Pin Function bit (except in XT and HS modes) 1 = OSC2 is clock output 0 = OSC2 is general purpose digital I/O pin
POSCMD<1:0>	FOSC	Immediate	Primary Oscillator Mode Select bits 11 = Primary oscillator disabled 10 = HS Crystal Oscillator mode 01 = XT Crystal Oscillator mode 00 = EC (External Clock) mode

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TABLE 20-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Base Instr #	Assembly Mnemonic	Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
47	RCALL	RCALL Expr	Relative Call	1	2	None
		RCALL Wn	Computed Call	1	2	None
48	REPEAT	REPEAT #lit14	Repeat Next Instruction lit14 + 1 times	1	1	None
		REPEAT Wn	Repeat Next Instruction (Wn) + 1 times	1	1	None
49	RESET	RESET	Software device Reset	1	1	None
50	RETFIE	RETFIE	Return from interrupt	1	3 (2)	None
51	RETLW	RETLW #lit10, Wn	Return with literal in Wn	1	3 (2)	None
52	RETURN	RETURN	Return from Subroutine	1	3 (2)	None
53	RLC	RLC f	f = Rotate Left through Carry f	1	1	C,N,Z
		RLC f, WREG	WREG = Rotate Left through Carry f	1	1	C,N,Z
		RLC Ws, Wd	Wd = Rotate Left through Carry Ws	1	1	C,N,Z
54	RLNC	RLNC f	f = Rotate Left (No Carry) f	1	1	N,Z
		RLNC f, WREG	WREG = Rotate Left (No Carry) f	1	1	N,Z
		RLNC Ws, Wd	Wd = Rotate Left (No Carry) Ws	1	1	N,Z
55	RRC	RRC f	f = Rotate Right through Carry f	1	1	C,N,Z
		RRC f, WREG	WREG = Rotate Right through Carry f	1	1	C,N,Z
		RRC Ws, Wd	Wd = Rotate Right through Carry Ws	1	1	C,N,Z
56	RRNC	RRNC f	f = Rotate Right (No Carry) f	1	1	N,Z
		RRNC f, WREG	WREG = Rotate Right (No Carry) f	1	1	N,Z
		RRNC Ws, Wd	Wd = Rotate Right (No Carry) Ws	1	1	N,Z
57	SE	SE Ws, Wnd	Wnd = sign-extended Ws	1	1	C,N,Z
58	SETM	SETM f	f = 0xFFFF	1	1	None
		SETM WREG	WREG = 0xFFFF	1	1	None
		SETM Ws	Ws = 0xFFFF	1	1	None
59	SL	SL f	f = Left Shift f	1	1	C,N,OV,Z
		SL f, WREG	WREG = Left Shift f	1	1	C,N,OV,Z
		SL Ws, Wd	Wd = Left Shift Ws	1	1	C,N,OV,Z
		SL Wb, Wns, Wnd	Wnd = Left Shift Wb by Wns	1	1	N,Z
		SL Wb, #lit5, Wnd	Wnd = Left Shift Wb by lit5	1	1	N,Z
60	SUB	SUB f	f = f – WREG	1	1	C,DC,N,OV,Z
		SUB f, WREG	WREG = f – WREG	1	1	C,DC,N,OV,Z
		SUB #lit10, Wn	Wn = Wn – lit10	1	1	C,DC,N,OV,Z
		SUB Wb, Ws, Wd	Wd = Wb – Ws	1	1	C,DC,N,OV,Z
		SUB Wb, #lit5, Wd	Wd = Wb – lit5	1	1	C,DC,N,OV,Z
61	SUBB	SUBB f	f = f – WREG – (\overline{C})	1	1	C,DC,N,OV,Z
		SUBB f, WREG	WREG = f – WREG – (\overline{C})	1	1	C,DC,N,OV,Z
		SUBB #lit10, Wn	Wn = Wn – lit10 – (\overline{C})	1	1	C,DC,N,OV,Z
		SUBB Wb, Ws, Wd	Wd = Wb – Ws – (\overline{C})	1	1	C,DC,N,OV,Z
		SUBB Wb, #lit5, Wd	Wd = Wb – lit5 – (\overline{C})	1	1	C,DC,N,OV,Z
62	SUBR	SUBR f	f = WREG – f	1	1	C,DC,N,OV,Z
		SUBR f, WREG	WREG = WREG – f	1	1	C,DC,N,OV,Z
		SUBR Wb, Ws, Wd	Wd = Ws – Wb	1	1	C,DC,N,OV,Z
		SUBR Wb, #lit5, Wd	Wd = lit5 – Wb	1	1	C,DC,N,OV,Z
63	SUBBR	SUBBR f	f = WREG – f – (\overline{C})	1	1	C,DC,N,OV,Z
		SUBBR f, WREG	WREG = WREG – f – (\overline{C})	1	1	C,DC,N,OV,Z
		SUBBR Wb, Ws, Wd	Wd = Ws – Wb – (\overline{C})	1	1	C,DC,N,OV,Z
		SUBBR Wb, #lit5, Wd	Wd = lit5 – Wb – (\overline{C})	1	1	C,DC,N,OV,Z
64	SWAP	SWAP.b Wn	Wn = nibble swap Wn	1	1	None
		SWAP Wn	Wn = byte swap Wn	1	1	None
65	TBLRDH	TBLRDH Ws, Wd	Read Prog<23:16> to Wd<7:0>	1	2	None

TABLE 22-9: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS (CONTINUED)

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions
DI60a	I _{ICL}	Input Low Injection Current	0	—	-5 ^(5,8)	mA	All pins except V _{DD} , V _{SS} , AV _{DD} , AV _{SS} , MCLR, V _{CAP} , SOSC _I , and SOSC _O
DI60b	I _{ICH}	Input High Injection Current	0	—	+5 ^(6,7,8)	mA	All pins except V _{DD} , V _{SS} , AV _{DD} , AV _{SS} , MCLR, V _{CAP} , SOSC _I , SOSC _O , and digital 5V-tolerant designated pins
DI60c	ΣI _{ICT}	Total Input Injection Current (sum of all I/O and control pins)	-20 ⁽⁹⁾	—	+20 ⁽⁹⁾	mA	Absolute instantaneous sum of all ± input injection currents from all I/O pins (I _{ICL} + I _{ICH}) ≤ ΣI _{ICT}

Note 1: Data in “Typ” column is at 3.3V, 25°C unless otherwise stated.

- 2:** The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3:** Negative current is defined as current sourced by the pin.
- 4:** See “Pin Diagrams” for a list of 5V tolerant pins.
- 5:** V_{IL} source < (V_{SS} – 0.3). Characterized but not tested.
- 6:** Non-5V tolerant pins V_{IH} source > (V_{DD} + 0.3), 5V tolerant pins V_{IH} source > 5.5V. Characterized but not tested.
- 7:** Digital 5V tolerant pins cannot tolerate any “positive” input injection current from input sources > 5.5V.
- 8:** Injection currents > | 0 | can affect the ADC results by approximately 4-6 counts.
- 9:** Any number and/or combination of I/O pins not excluded under I_{ICL} or I_{ICH} conditions are permitted provided the mathematical “absolute instantaneous” sum of the input injection currents from all pins do not exceed the specified limit. Characterized but not tested.
- 10:** These parameters are characterized, but not tested.

PIC24HJ12GP201/202

FIGURE 22-5: TIMER1, 2, 3 AND 4 EXTERNAL CLOCK TIMING CHARACTERISTICS

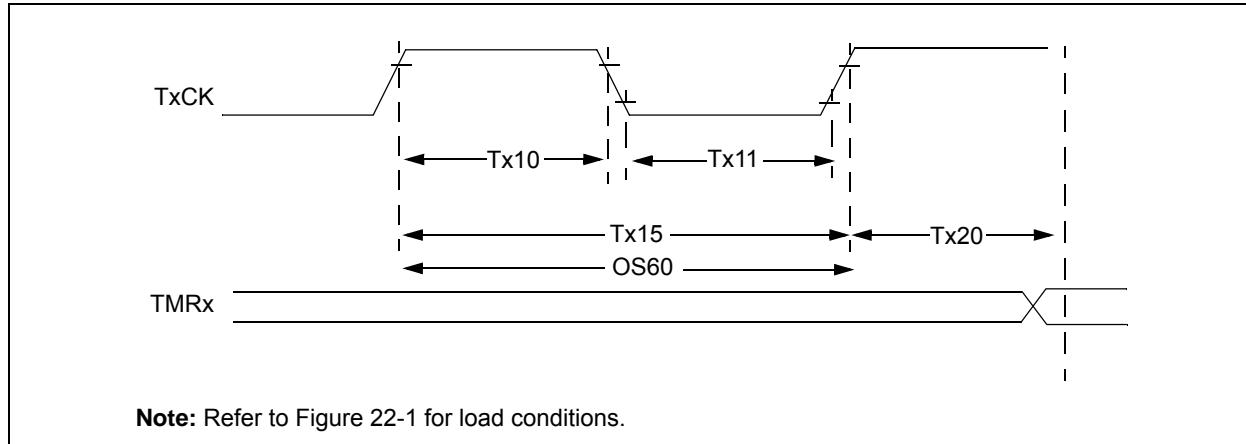


TABLE 22-22: TIMER1 EXTERNAL CLOCK TIMING REQUIREMENTS⁽¹⁾

AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for Extended				
Param No.	Symbol	Characteristic		Min	Typ	Max	Units	Conditions
TA10	TtxH	TxCK High Time	Synchronous, no prescaler	$T_{CY} + 20$	—	—	ns	Must also meet parameter TA15. N = prescale value (1, 8, 64, 256)
			Synchronous, with prescaler	$(T_{CY} + 20)/N$	—	—	ns	
			Asynchronous	20	—	—	ns	
TA11	TtxL	TxCK Low Time	Synchronous, no prescaler	$(T_{CY} + 20)$	—	—	ns	Must also meet parameter TA15. N = prescale value (1, 8, 64, 256)
			Synchronous, with prescaler	$(T_{CY} + 20)/N$	—	—	ns	
			Asynchronous	20	—	—	ns	
TA15	TtxP	TxCK Input Period	Synchronous, no prescaler	$2 T_{CY} + 40$	—	—	ns	—
			Synchronous, with prescaler	Greater of: 40 ns or $(2 T_{CY} + 40)/N$	—	—	—	N = prescale value (1, 8, 64, 256)
			Asynchronous	40	—	—	ns	—
OS60	Ft1	SOSCI/T1CK Oscillator Input frequency Range (oscillator enabled by setting bit TCS (T1CON<1>))		DC	—	50	kHz	—
TA20	TCKEXTMRL	Delay from External TxCK Clock Edge to Timer Increment		$0.75 T_{CY} + 40$		$1.75 T_{CY} + 40$	—	—

Note 1: Timer1 is a Type A.

FIGURE 22-17: I²Cx BUS START/STOP BITS TIMING CHARACTERISTICS (MASTER MODE)

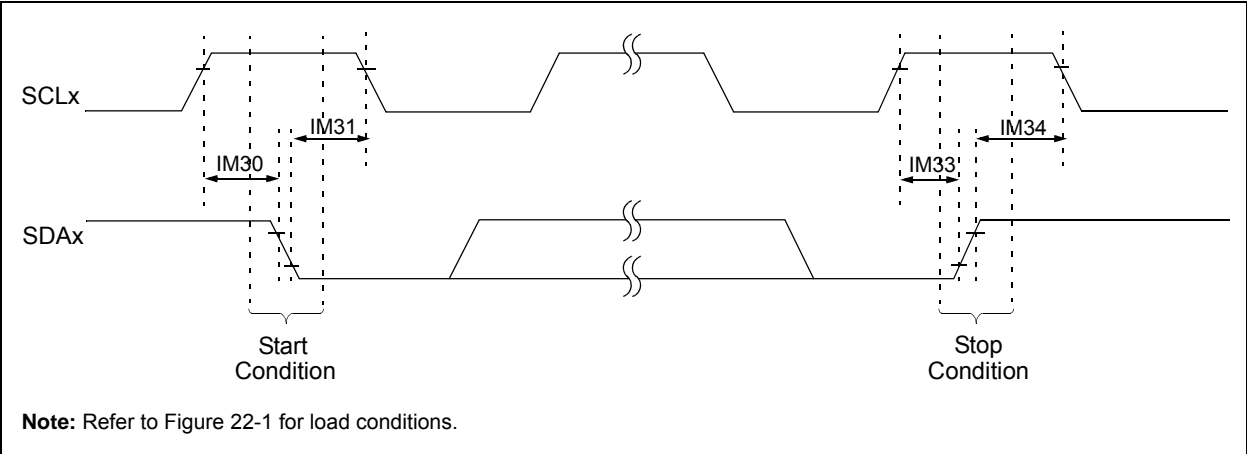
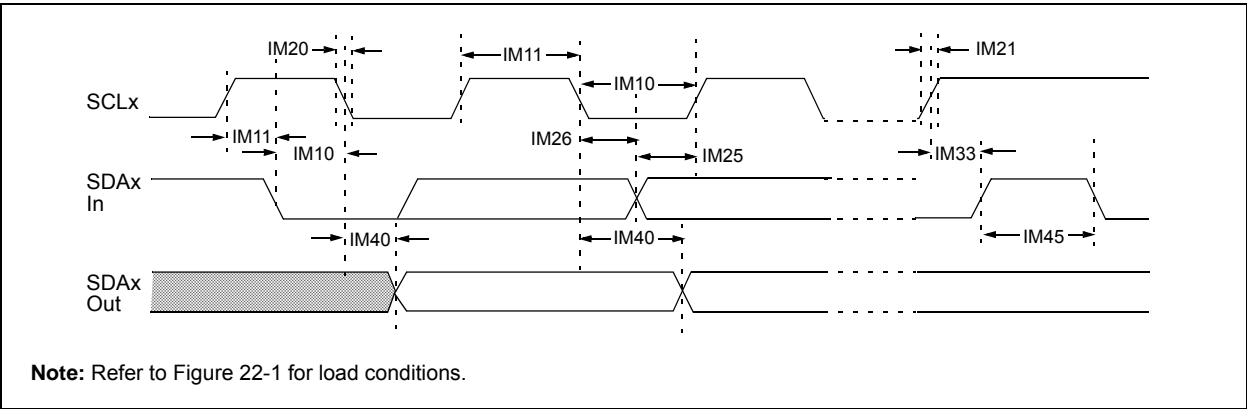
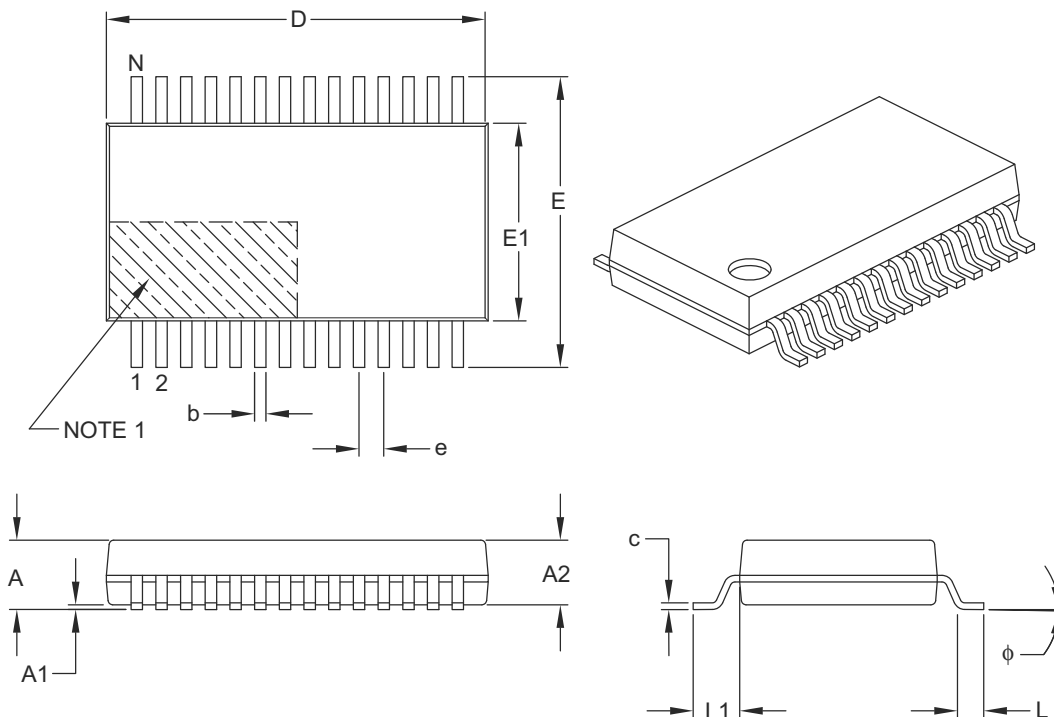


FIGURE 22-18: I²Cx BUS DATA TIMING CHARACTERISTICS (MASTER MODE)



28-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	28		
Pitch	e	0.65 BSC		
Overall Height	A	–	–	2.00
Molded Package Thickness	A2	1.65	1.75	1.85
Standoff	A1	0.05	–	–
Overall Width	E	7.40	7.80	8.20
Molded Package Width	E1	5.00	5.30	5.60
Overall Length	D	9.90	10.20	10.50
Foot Length	L	0.55	0.75	0.95
Footprint	L1	1.25 REF		
Lead Thickness	c	0.09	–	0.25
Foot Angle	φ	0°	4°	8°
Lead Width	b	0.22	–	0.38

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B

APPENDIX A: REVISION HISTORY

Revision A (February 2007)

This is the initial released version of this document.

Revision B (May 2007)

This revision includes the following corrections and updates:

- Minor typographical and formatting corrections throughout the data sheet text.
- New content:
 - Addition of bullet item (16-word conversion result buffer) (see **Section 17.1 “Key Features”**)
- Figure update:
 - Oscillator System Diagram (see Figure 7-1)
 - WDT Block Diagram (see Figure 18-2)
- Equation update:
 - Serial Clock Rate (see Equation 15-1)
- Register updates:
 - Clock Divisor Register (see Register 7-2)
 - PLL Feedback Divisor Register (see Register 7-3)
 - Peripheral Pin Select Input Registers (see Register 9-1 through Register 9-9)
 - ADC1 Input Channel 1, 2, 3 Select Register (see Register 17-4)
 - ADC1 Input Channel 0 Select Register (see Register 17-5)
- Table updates:
 - CNEN2 (see Table 3-2 and Table 3-3)
 - Reset Flag Bit Operation (see Table 5-1)
 - Configuration Bit Values for Clock Operation (see Table 7-1)
- Operation value update:
 - IOLOCK set/clear operation (see **Section 9.4.3.1 “Control Register Lock”**)
- The following tables in **Section 21.0 “Electrical Characteristics”** have been updated with preliminary values:
 - Updated Max MIPS for -40°C to +125°C Temp Range (see Table 21-1)
 - Added new parameters for +40°C and updated Typical and Max values for most parameters (see Table 21-5)
 - Added new parameters for +40°C and updated Typical and Max values for most parameters (see Table 21-6)
 - Added new parameters for +40°C and updated Typical and Max values for most parameters (see Table 21-7)
 - Added new parameters for +40°C and updated Typical and Max values for most parameters (see Table 21-8)
 - Updated parameter DI51, added parameter DI51a (see Table 21-9)
 - Added Note 1 (see Table 21-11)
 - Updated parameter OS30 (see Table 21-16)
 - Updated parameter OS52 (see Table 21-17)
 - Updated parameter F20, added Note 2 (see Table 21-18)
 - Updated parameter TA15 (see Table 21-22)
 - Updated parameter TB15 (see Table 21-23)
 - Updated parameter TC15 (see Table 21-24)
 - Updated parameters AD05, AD06, AD07, AD08, AD10, and AD11; added parameters AD05a and AD06a; added Note 2; modified ADC Accuracy headings to include measurement information (see Table 21-34)
 - Separated the ADC Module Specification table in to three tables (see Table 21-34, Table 21-35, and Table 21-36)
 - Updated parameter AD50 (see Table 21-37)
 - Updated parameters AD50 and AD57 (see Table 21-38)